# 2SB0950 (2SB950), 2SB0950A (2SB950A)

# Silicon PNP epitaxial planar type darlington

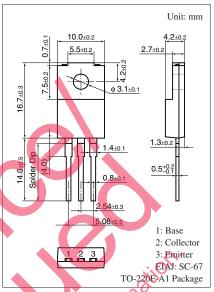
For power amplification and switching Complementary to 2SD1276 and 2SD1276A

#### ■ Features

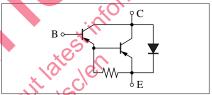
- High forward current transfer ratio h<sub>FE</sub>
- High-speed switching
- Full-pack package which can be installed to the heat sink with one screw

# ■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter		Symbol	Rating	Unit	
Collector-base voltage	2SB0950	$V_{CBO}$	-60	V	
(Emitter open)	2SB0950A		-80		
Collector-emitter voltage	2SB0950	V <sub>CEO</sub>	-60	V	
(Base open)	2SB0950A		-80		
Emitter-base voltage (Collector open)		V <sub>EBO</sub>	-5	V	
Collector current		$I_{C}$	-4	A	
Peak collector current		$I_{CP}$	-8	A	
Collector power		P <sub>C</sub>	40	W	
dissipation	$T_a = 25^{\circ}C$		2		
Junction temperature		T <sub>j</sub>	150	°C	
Storage temperature		$T_{stg}$	-55 to +150	°C	



#### **Internal Connection**



# ■ Electrical Characteristics T<sub>C</sub> = 25°C ± 3°C

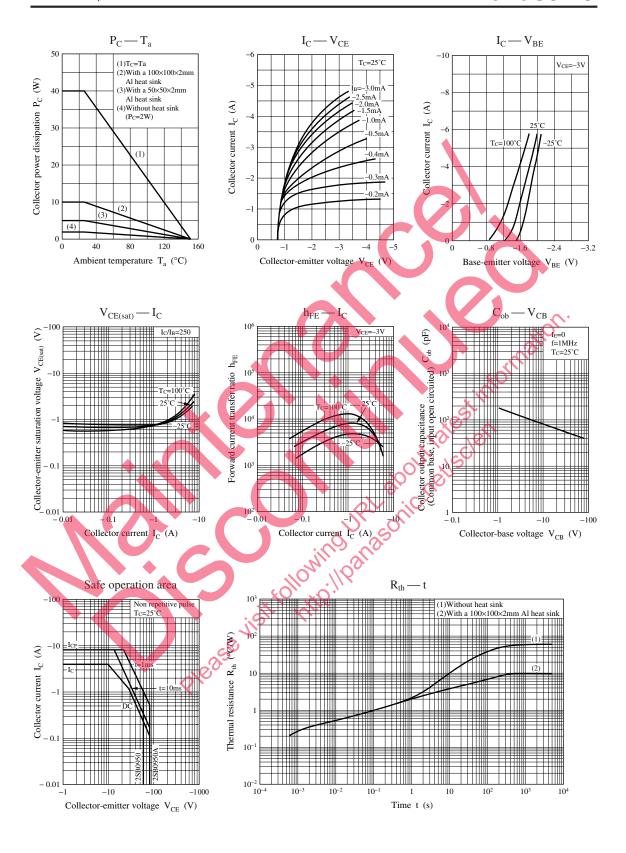
Parameter	Symbol	Conditions	Тур	Max	Unit
Collector-emitter voltage 2SB0950	V <sub>CEO</sub>	$I_{\rm C} = -30 \text{ mA}, I_{\rm B} = 0$ $-60$			V
(Base open) 2SB0950A	N N	-80			
Base-emitter voltage	$V_{BE}$	$V_{CE} = -3 \text{ V}, I_{C} = -3 \text{ A}$		-2.5	V
Collector-base cutoff 2SB0950	I <sub>CBO</sub>	$V_{CB} = -60 \text{ V}, I_E = 0$		-200	μΑ
current (Emitter open) 2SB0950		$V_{CB} = -80 \text{ V}, I_{E} = 0$		-200	
Collector-emitter cutoff 2SB0950	I <sub>CEO</sub>	$V_{CH} = -30 \text{ V}, \hat{I}_{B} = 0$		-500	μΑ
current (Base open) 2SB0950A	Λ	$V_{CE} = -40 \text{ V}, I_{B} = 0$		-500	
Emitter-base cutoff current (Collector open)	I <sub>EBO</sub>	$V_{EB} = -5 \text{ V}, I_C = 0$		-2	mA
Forward current transfer ratio	heel	$V_{CE} = -3 \text{ V}, I_C = -0.5 \text{ A}$ 1 000			_
	h <sub>FE2</sub> *	$V_{CE} = -3 \text{ V}, I_C = -3 \text{ A}$ 1 000		10 000	
Collector-emitter saturation voltage	V <sub>CE(sat)1</sub>	$I_C = -3 \text{ A}, I_B = -12 \text{ mA}$		-2	V
	V <sub>CE(sat)2</sub>	$I_C = -5 \text{ A}, I_B = -20 \text{ mA}$		-4	V
Transition frequency	$f_T$	$V_{CE} = -10 \text{ V}, I_{C} = -0.5 \text{ A}, f = 1 \text{ MHz}$	20		MHz
Turn-on time	t <sub>on</sub>	$I_C = -3 \text{ A}, I_{B1} = -12 \text{ mA}, I_{B2} = 12 \text{ mA}$	0.3		μs
Storage time	t <sub>stg</sub>	$V_{CC} = -50 \text{ V}$	2		μs
Fall time	t <sub>f</sub>		0.5		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

#### 2. \*: Rank classification

Rank	Rank R		Р	
h <sub>FE2</sub>	1000 to 2500	2000 to 5000	4000 to 10000	

Note) The part numbers in the parenthesis show conventional part number.



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